



TRY PRECISION



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TRY-PRECISION is a professional supplier of industrial bond testers, utilizing precision sensing technology. We are independent, innovative, and persistent in the research, development, and production of our core technology. We hold several national patents in the automatic control and precision measurement technologies.



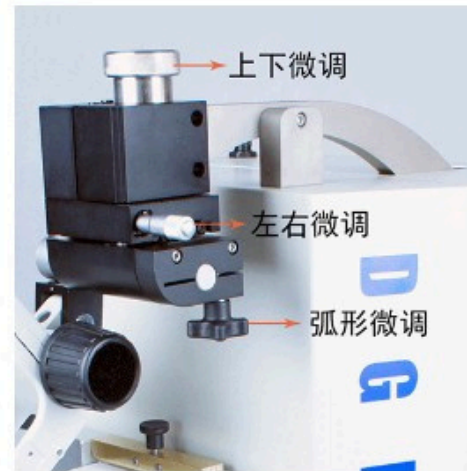
SEALED MOBILE PLATFORM

MFM series multi-functional micro solder joint strength tester is sealed on the mobile platform, the motor is not exposed, with high safety and longer maintenance cycle.



COMFORTABLE ROCKER CONTROL

Excellent equipment control performance, all-round protection measures, left and right rocker controllers that can be placed freely, and rocker controllers that are comfortable to operate.



PRECISE PRICE ADJUSTMENT OF MICROSCOPE

MFM series multi-functional micro solder joint strength tester can achieve precise adjustment in six directions, convenient and precise.



GENERAL CONTROL LINE

MFM series multi-functional micro solder joint strength tester only needs a universal USB printing data line to connect the device and PC, and can control the operation of the device



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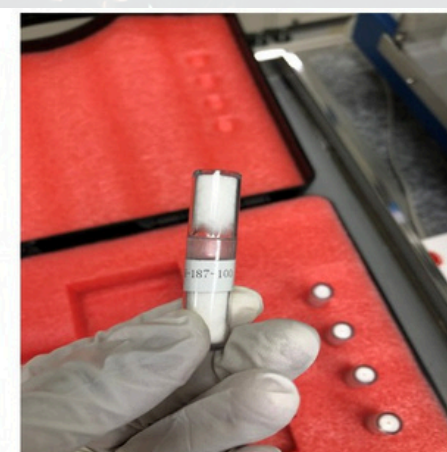
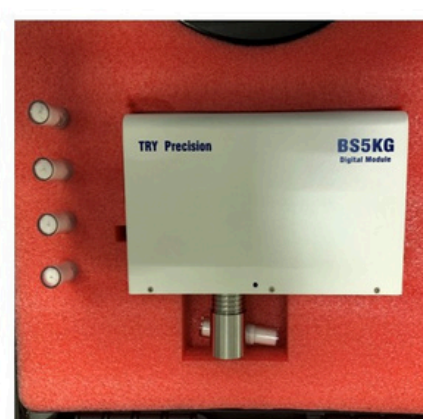
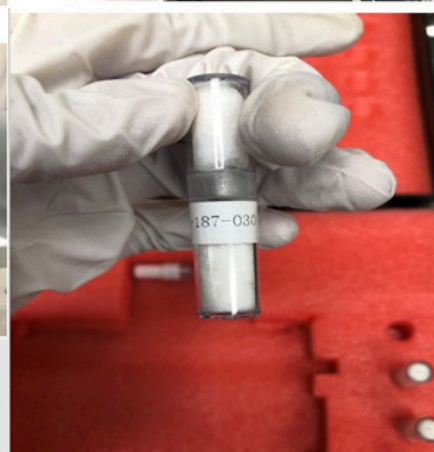
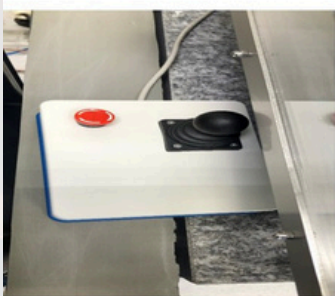
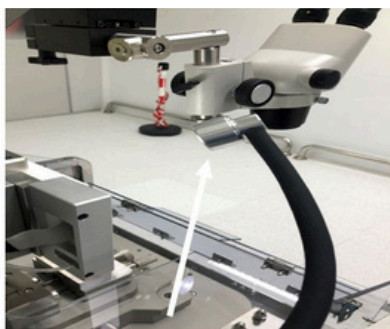
As the industry leader in the field of Bond Testing, RUI YIN(HK) CO., Limited supplies automatic, semi-automatic multi-function Bond Tester and material tester with advanced technology and superior performance in long-term for semiconductor integrated circuit and microelectronics assembly industry.

Owning a lot of advanced core technologies, perfect market and service system.

TRY-PRECISION also can provide deep technical support and efficient sales service so as to offer both high-quality products and service for global semi-conductor enterprises.

Currently our major product are MFM Series Bond Tester / ABT Series Bond Tester / FS-1000 Material Tester /ABT2000W Series Wafer Level bump shear tester .

Our Products cover China(include Hongkong and Taiwan) and exported to Japan , Korea and SE Asia, We have perfect sales and service system.



length	520mm
width	620mm (Include lift and right joysticks)
height	700mm
weight	65KG
Power supply	110VAC or 220VAC@4.0A 50-60Hz
Compressed air supply	4.5-6Bar
Vacuum supply	550mm Hg
Other supply link	6mm OD / 4mm ID
computer	Lenovo/Dell/or compatible PC
System software platform	Windows7 / Windows 10
Magnification of microscope	60X (Standard)
Brand of microscope	Leica / Nikon / Olympus
X axes stage	100mm
X axes resolution	Less than 0,125um
Y axes stage	100mm
Y axes resolution	Less than 0,125um
Z axes stage	60mm
Z axes resolution	Less than 0,125um
Z axes height of test and accuracy of position	Less than plus-minus 1um
Y axes maximum load	200KG (Standard)
Z axes maximum load	20KG
Tester maximum load	500KG

